Octal D Flip-Flop with Enable

The SN74LS377 is an 8-bit register built using advanced Low Power Schottky technology. This register consists of eight D-type flip-flops with a buffered common clock and a buffered common clock enable.

- 8-Bit High Speed Parallel Registers
- Positive Edge-Triggered D-Type Flip Flops
- Fully Buffered Common Clock and Enable Inputs
- True and Complement Outputs
- Input Clamp Diodes Limit High Speed Termination Effects

GUARANTEED OPERATING RANGES

Symbol	Parameter	Min	Тур	Max	Unit
V _{CC}	Supply Voltage	4.75	5.0	5.25	V
T _A	Operating Ambient Temperature Range	0	25	70	°C
I _{OH}	Output Current – High			-0.4	mA
I _{OL}	Output Current – Low			8.0	mA



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> LOW POWER SCHOTTKY



PLASTIC N SUFFIX CASE 738

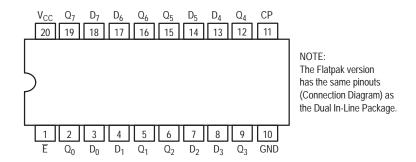


SOIC DW SUFFIX CASE 751D

ORDERING INFORMATION

Device	Package	Shipping
SN74LS377N	16 Pin DIP	1440 Units/Box
SN74LS377DW	16 Pin	2500/Tape & Reel

CONNECTION DIAGRAM DIP (TOP VIEW)

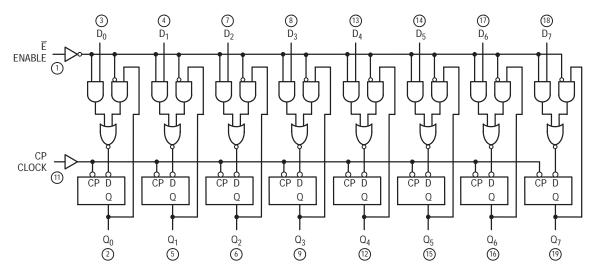


			LOADING (Note a)			
PIN NAME	S	HIGH	LOW			
Ē	Enable (Active LOW) Input	0.5 U.L.	0.25 U.L.			
$D_0 - D_3$	Data Inputs	0.5 U.L.	0.25 U.L.			
CP	Clock (Active HIGH Going Edge) Input	0.5 U.L.	0.25 U.L.			
$Q_0 - Q_3$	True Outputs	10 U.L.	5 U.L.			
$\overline{Q}_0 - \overline{Q}_3$	Complemented Outputs	10 U.L.	5 U.L.			

NOTES:

a) 1 TTL Unit Load (U.L.) = 40 μ A HIGH/1.6 mA LOW.

LOGIC DIAGRAM



DC CHARACTERISTICS OVER OPERATING TEMPERATURE RANGE (unless otherwise specified)

		Limits					
Symbol	Parameter	Min	Тур	Max	Unit	Tes	t Conditions
V _{IH}	Input HIGH Voltage	2.0			V	Guaranteed Input HIGH Voltage for All Inputs	
V _{IL}	Input LOW Voltage			0.8	V	Guaranteed Input LOW Voltage for All Inputs	
V _{IK}	Input Clamp Diode Voltage		-0.65	-1.5	V	V _{CC} = MIN, I _{IN} = -18 mA	
V _{OH}	Output HIGH Voltage	2.7	3.5		V	V_{CC} = MIN, I_{OH} = MAX, V_{IN} = V_{IH} or V_{IL} per Truth Table	
W	Output I OW/ Valtage		0.25	0.4	٧	I _{OL} = 4.0 mA	$V_{CC} = V_{CC} MIN,$
V _{OL}	Output LOW Voltage		0.35	0.5	٧	I _{OL} = 8.0 mA	V _{IN} = V _{IL} or V _{IH} per Truth Table
	Input HICH Current			20	μА	V _{CC} = MAX, V _{IN} =	= 2.7 V
l IH	Input HIGH Current			0.1	mA	V _{CC} = MAX, V _{IN} =	= 7.0 V
I _{IL}	Input LOW Current			-0.4	mA	V _{CC} = MAX, V _{IN} = 0.4 V	
I _{OS}	Short Circuit Current (Note 1)	-20		-100	mA	V _{CC} = MAX	
Icc	Power Supply Current			28	mA	V _{CC} = MAX, NOT	E 1

NOTE: With all inputs open and GND applied to all data and enable inputs, I_{CC} is measured after a momentary GND, then 4.5 V is applied to clock. Note 1: Not more than one output should be shorted at a time, nor for more than 1 second.

AC CHARACTERISTICS (T_A = 25°C, V_{CC} = 5.0 V)

			Limits				
Symbol	Parameter	Min	Тур	Max	Unit	Test Conditions	
f _{MAX}	Maximum Clock Frequency	30	40		MHz	V _{CC} = 5.0 V C _L = 15 pF	
t _{PLH} t _{PHL}	Propagation Delay, Clock to Output		17 18	27 27	ns		

AC SETUP REQUIREMENTS ($T_A = 25$ °C, $V_{CC} = 5.0 \text{ V}$)

			Limits				
Symbol	Parameter		Min	Тур	Max	Unit	Test Conditions
t _W	Any Pulse Width		20			ns	
t _s	Data Setup Time		20			ns	
_	Enable Setup	Inactive — State	10			ns	$V_{CC} = 5.0 \text{ V}$
t _s	Time	Active — State	25			ns	
t _h	Any Hold Time		5.0			ns	

DEFINITION OF TERMS

SETUP TIME (ts) — is defined as the minimum time required for the correct logic level to be present at the logic input prior to the clock transition from LOW-to-HIGH in order to be recognized and transferred to the outputs.

 $HOLD\ TIME\ (t_h)$ — is defined as the minimum time following the clock transition from LOW-to-HIGH that the

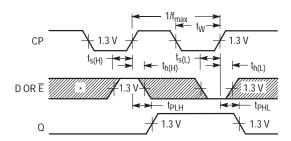
logic level must be maintained at the input in order to ensure continued recognition. A negative HOLD TIME indicates that the correct logic level may be released prior to the clock transition from LOW-to-HIGH and still be recognized.

TRUTH TABLE

E	СР	D _n	Q _n	Qn
Н		Х	No Change	No Change
L		Н	Н	L
L	\	L	L	Н

L = LOW Voltage Level H = HIGH Voltage Level X = Immaterial

AC WAVEFORM

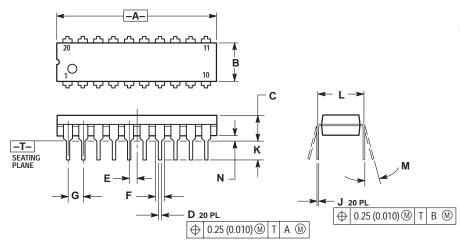


^{*}The shaded areas indicate when the input is permitted to change for predictable output performance.

PACKAGE DIMENSIONS

N SUFFIX PLASTIC PACKAGE

CASE 738-03 ISSUE E



- NOTES:

 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

 2. CONTROLLING DIMENSION: INCH.

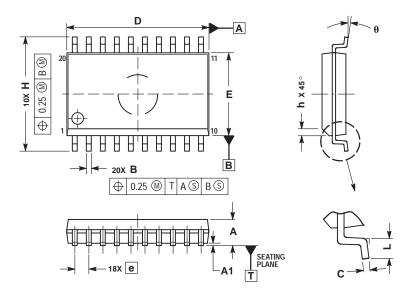
 3. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.

 4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.

	INC	HES	MILLIN	IETERS	
DIM	MIN	MAX	MIN	MAX	
Α	1.010	1.070	25.66	27.17	
В	0.240	0.260	6.10	6.60	
С	0.150	0.180	3.81	4.57	
D	0.015	0.022	0.39	0.55	
Ε	0.050	BSC	1.27 BSC		
F	0.050	0.070	1.27	1.77	
G	0.100	BSC	2.54 BSC		
J	0.008	0.015	0.21	0.38	
K	0.110	0.140	2.80	3.55	
L	0.300	BSC	7.62	BSC	
M	0 °	15°	0°	15°	
N	0.020	0.040	0.51	1.01	

PACKAGE DIMENSIONS

D SUFFIX PLASTIC SOIC PACKAGE CASE 751D-05 ISSUE F



- NOTES:
 1. DIMENSIONS ARE IN MILLIMETERS.
 2. INTERPRET DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994.
 3. DIMENSIONS D AND E DO NOT INCLUDE MOLD PROTRUSION.
 4. MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.
 5. DIMENSION B DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE PROTRUSION SHALL BE 0.13 TOTAL IN EXCESS OF B DIMENSION AT MAXIMUM MATERIAL CONDITION.

	MILLIMETERS					
DIM	MIN	MAX				
Α	2.35	2.65				
A1	0.10	0.25				
В	0.35	0.49				
С	0.23	0.32				
D	12.65	12.95				
Ε	7.40	7.60				
е	1.27	BSC				
Н	10.05	10.55				
h	0.25	0.75				
L	0.50	0.90				
θ	0 °	7 °				

Notes

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